AIRCHILD

SEMICONDUCTOR IM

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

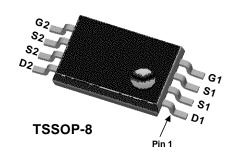
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

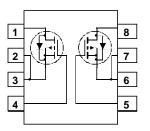
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -3.8 A, -20 V, $R_{DS(ON)} = 0.043 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.070 \ \Omega \ @ V_{GS} = -2.5 V$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Unit
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1a)	-3.8	A
	- Pulsed		-30	
P _D	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
	1	(Note 1b)	208	

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
2504P	FDW2504P	13"	12mm	3000 units

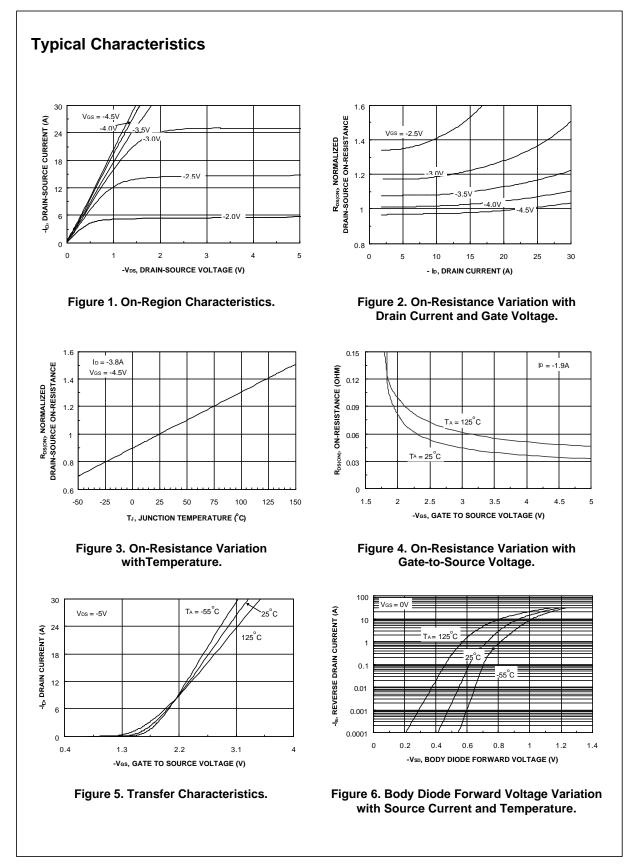
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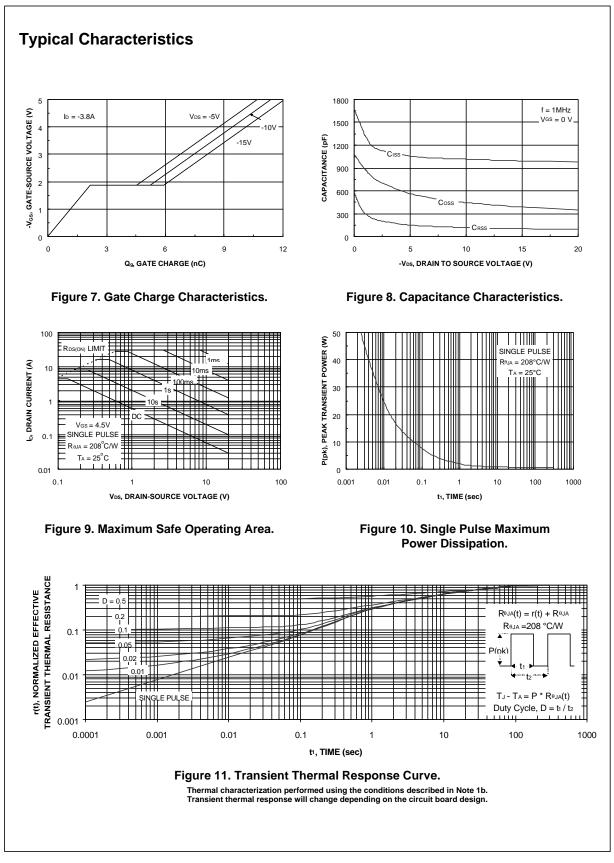
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A,Referenced to 25° C		-16		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
	Gate-Body Leakage, Forward	$V_{GS} = -12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
IGSSR	Gate-Body Leakage, Reverse	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics (Note 2)			•	•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.6	-1	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{c} V_{GS} = -4.5 \ V, I_D = -3.8 \ A \\ V_{GS} = -2.5 \ V, I_D = -3.0 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -3.8A, \ T_J = 125 \ ^\circ C \end{array} $		0.036 0.056 0.049	0.043 0.070 0.069	Ω
I _{D(on)}	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-15			А
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -3.5 A$		13.2		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$		1015		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		446		pF
C _{rss}	Reverse Transfer Capacitance	-		118		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -5 V$, $I_D = -1 A$,		11	20	ns
t _r	Turn-On Rise Time	$V_{GS} = -4.5$ V, $R_{GEN} = 6 \Omega$		18	32	ns
t _{d(off)}	Turn–Off Delay Time			34	55	ns
t _f	Turn–Off Fall Time			34	55	ns
Q _g	Total Gate Charge	$V_{DS} = -5 V$, $I_D = -3.8 A$,		9.7	16	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		2.2		nC
Q _{gd}	Gate-Drain Charge			2.4		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings			•	
l _s	Maximum Continuous Drain–Source Diode Forward Current				-0.83	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_{S} = -0.83 \ A \ (Note 2)$		-0.7	-1.2	V

the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

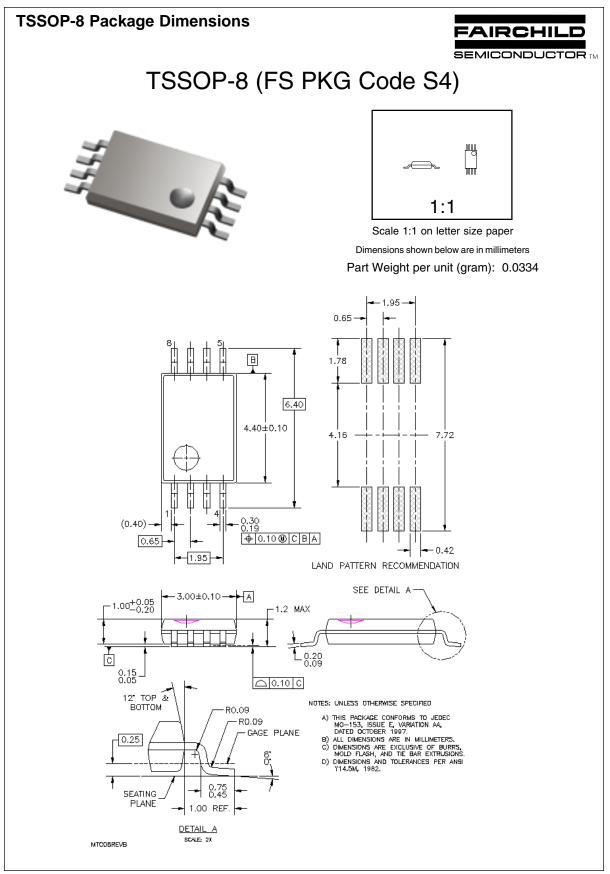
a) R_{θJA} is 125°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.
b) R_{θJA} is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%





FDW2504P Rev. C (W)



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